TOSHIBA CMOS DIGITAL INTEGRATED CIRCUIT SILICON MONOLITHIC

TC9028P, TC9028F

INFRARED REMOTE CONTROL TRANSMITTING CMOS LSI WITH MICROCONTROLLING

TC9028P, TC9028F is CMOS LSI for Infrared Remote Control Transmitting suitable for Remote Controlling TV, VCR, Video Disk, CD-Player etc. Using a 4bit Microcontroller, various transmittings are structured by a programming.

FEATURES

Low voltage operation : 2.0~4.0V

: $\leq 1 \mu A$ (at Hold Function) Low power dissipation

Program memory (ROM) capacity: 768 x 8bit

: 16 x 4bit Data memory (RAM) capacity

: 44kinds Instruction

Timer / Counter : 10~15bit

I/O port (15pins)

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1/0 : 2ports 8pins : 1port 4pins Input : 1port 3pins Output

(Including High Current Output)

Subcarrier frequency : f_{osc} / 12, f_{osc} / 8

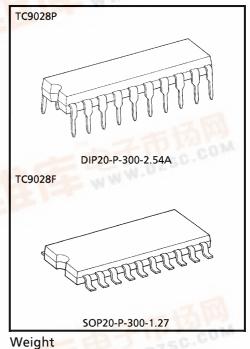
fosc/24, fosc/16 (Option)

: 400~800kHz Oscillating frequency

Instruction execution time : $11\mu s$ (at 455kHz)

: DIP20 [TC9028P] Package

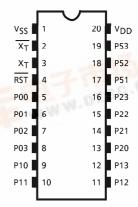
SOP20 [TC9028F]



DIP20-P-300-2.54A : 1.4g (Typ.)

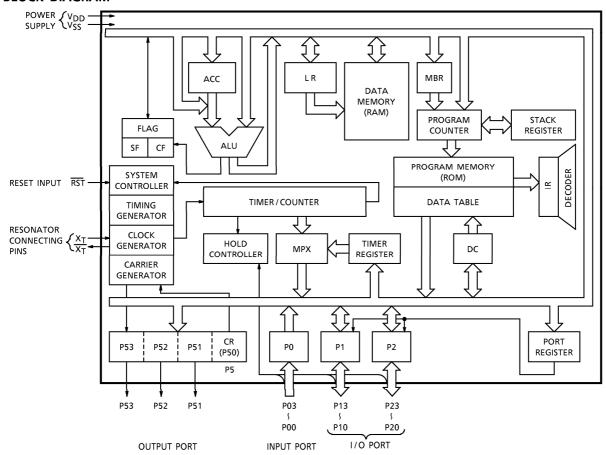
SOP20-P-300-1.27 : 0.48g (Typ.)

PIN CONNECTION (TOP VIEW)



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BLOCK DIAGRAM



PIN FUNCTION

PIN No.	SYMBOL	PIN NAME	FUNCTION					
1	Vss	Dayyor Cumply	V 20-40V 3V (Turn)					
20	V_{DD}	Power Supply	$I_{DD} = 2.0 \sim 4.0 \text{V}, 3 \text{V} \text{ (Typ.)}$					
2	$\overline{X_T}$	Output for Osc.	Resonator connecting pins. Connects ceramic resonator with					
3	X _T	Input for Osc.	capacitor. Built-in feedback resistance.					
4	RST	Reset Input	\overline{RST} for going reset. Be held to "L" (≥ 3 instruction cycles)					
5~8	P00~P03	Input Port P0	4bit input port. Built-in pulldown resistance.					
9~12	P10~P13	I/O Port P1	4bit I/O ports with latch. Input/output mode can be specified by [MOV A, P] instruction.					
13~16	P20~P23	I/O Port P2	Built-in pulldown resistance.					
17	P51	Output Port P51	Pch open drain output port.					
18	P52	Output Port P52	High current output port. For driving indication LED.					
19	P53	Output Port P53	High current output port. For driving infrared LED.					

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OPERATION

- 1. Configuration
 - (1) Program counter (PC)
 - (2) Memory bank register (MBR)
 - (3) Stack register (STACK)
 - (4) Data counter (DC)
 - (5) Program memory (ROM)
 - (6) L register (LR)
 - (7) Data memory (RAM)
 - (8) Arithmetic and Logic Unit (ALU), Accumulator
 - (9) Flags
 - (10) Clock generator, Timing generator
 - (11) I/O ports
 - a. Port register (PR)
 - b. Command register (CR)
 - (12) Timer counter
 - a. Timer register (TR)
 - b. Timer counter output
 - c. Watch dog timer output
 - (13) Hold mode control circuit
 - (14) Reset circuit

Following is a description of the hardware configuration and operation of the components listed above.

2. Internal CPU functions

2.1 Program counter (PC)

The program counter is a 10bit binary counter which holds the program memory address of the next instruction to be executed.

The program counter is normally incremented for each instruction fetch. When branch instructions and subroutine instructions are executed, the values specified in Table 2.1 are set. The program counter is initialized to 0 at reset.

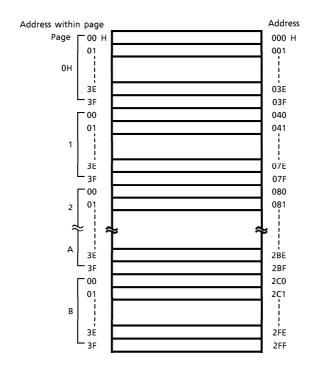


Figure 2.1 Program memory configuration

Table 2.1 Program counter values depending on conditions

	<u>J</u>		des depending on t										
						PR	OGR	AM C	OUNT	ER (Po	C)		
11	NSTRUCTION OR OPERATION	CONDITION			PAGE ASSIGNMENT					SS SP /ITHIN			N
					PC ₈	PC ₇	PC ₆	PC ₅	PC ₄	PC ₃	PC ₂	PC ₁	PC ₀
	LD MDD //L	SF = 1 (when branch	Men	nory b	ank		Value	e dire	ctly sp	ecifie	ed by	BSS
	LD MBR, #k	conditi	on is satisfied)	regis	ter co	ontents	6	instru	uction				
	BSS a	SF = 0 (when branch condition is not satisfied)						+	2				
Execution		CF 1	Lower 6 bits of address ≠ 111111	No change				e dire	ctly sp	ecifie	ed by		
	BSS a	SF = 1	Lower 6 bits of address = 111111	+ 1			Value directly specified by instruction						
[유		SF = 0		+ 1									
Instruction	CALLS a		_		0	0	0	0		e dire by ins			0
_	RET		_			Va	lue i	restore	d fro	m sta	ck		
	Instructions other than above		_					+	· 1				
	Reset		_	0	0	0	0	0	0	0	0	0	0

2.2 Memory bank register (MBR)

The memory bank register is a 4bit write-only register. It holds the page specification (upper 4 bits of the program counter) when a branch is made anywhere in program memory.

2.3 Stack register (STACK)

The stack is a 10bit register. When the [CALLS a] instruction is executed, the stack register saves the contents of the program counter (return address) before the program jumps to the processing routine.

Only one level of subroutines can be used. When there are two calls, the first return address is overwritten when the second return address is saved to the stack register. When the program returns from the processing routine, execution of the [RET] instruction restores the contents of the stack register to the program counter.

2.4 Data counter (DC)

When fixed data stored in the data table in program memory (ROM) are read, the data counter (DC) are used to specify 4 bits of the address.

In addition to transferring data to the accumulator, the data counter is also equipped with increment and decrement functions and can therefore be used as a general-purpose register.

Fixed data stored in the data table can be read using the table look-up instruction. When the table look-up instruction is executed, the upper 6 bits of the ROM address are "101111" and the lower 4 bits are the contents of the data counter (DC). These bits specify the last 16 bytes (addresses 2F0~2FFH) of program memory for fixed data.

2.5 Program memory (ROM)

Program memory stores program and fixed data. The next instruction to be executed is read from the address indicated by the program counter.

Physical program memory doesn't exist in addresses 300~3FFH.

When this area is read on the program, 7FH ([NOP] instruction) is read.

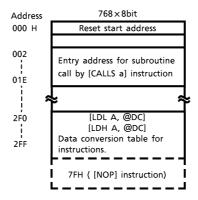


Figure 2.2 Program memory map

2.6 L register (LR)

The L register is a 4bit register. It is used as a data memory (RAM) address pointer. It can also be used as a general-purpose register.

2.7 Data memory (RAM)

Data memory stores data to be processed by the user.

There are two data memory addressing modes. One is register indirect addressing mode, where the L register specifies an address. The other is direct addressing mode, where the lower 3 bits of the instruction field directly specify an address.

Figure 2.3 shows the L register and data memory configuration.

The data memory contents are undefined at reset. Make initial settings using the initialization routine.

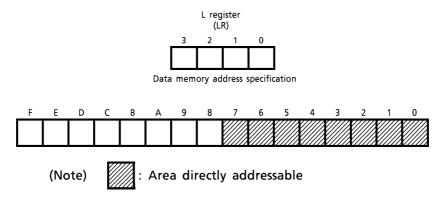


Figure 2.3 L register and data memory configuration

2.8 ALU, Accumulator

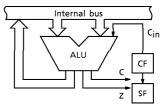
2.8.1 ALU

The ALU is a circuit which performs various operations on 4bit binary data.

The ALU performs operations according to instructions and outputs results (4bit), carry data (C) and zero detection data (Z).

2.8.2 Accumulator (ACC)

The accumulator is a 4bit register. It stores source data and results.



(Note) Cin indicates carry input specified by instruction.

Figure 2.4 ALU and flags



Figure 2.5 Accumulator

2.9 Flags (FLAG)

There are two types of flags: carry flag (CF) and status flag (SF). These are set and cleared according to conditions specified by instructions. The status flag is initialized to 1 at reset.

2.10 Clock generator, Timing generator

Figure 2.6 shows the clock generator and timing generator configuration.

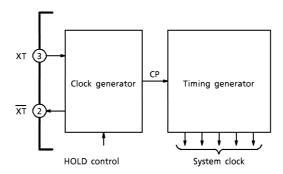


Figure 2.6 Clock generator and timing generator

2.10.1 Clock generator

The clock generator is a circuit which generates the fundamental clock pulse (CP) as the basis for the system clock supplied to the CPU. The fundamental clock is easily established by connecting the oscillator to the XT and XT pins. A clock can also be input from an external oscillator.

Clock input to the XT pin is used as the fundamental clock.

The clock generator stops oscillation during hold mode.

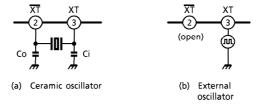


Figure 2.7 Typical oscillator connections

2.10.2 Timing generator

The timing generator is a circuit which uses the fundamental clock to generate various system clocks for the CPU and peripheral hardware.

2.10.3 Instruction cycle

Instructions and internal hardware operations are executed in sync with the fundamental clock. The minimum unit of instruction execution is called the instruction cycle. TC9028P and TC9028F has 1 and 2-cycle instructions. An instruction cycle consists of 5 states (S0-S4). Each state consists of 1 fundamental clock. Therefore, the instruction cycle time is 5/fc[s].

3. Peripheral hardware functions

3.1 Ports

The following functions are executed using I/O instructions (4 types): key scan, send signal output, send display output, internal circuit control. This system features the 2 types of ports listed below. Addresses (00-05H) are allocated to these ports:

① I/O ports : key scan, send signal output, send display output

② Command register : internal circuit control

Ports are selected by specifying port addresses with I/O instructions. The port register controls input and output of programmable I/O ports.

3.1.1 Port register (PR)

The port register is a 4bit write-only register. It is used for selecting input or output mode for programmable I/O ports. Since an option is used to select input or output mode during hold, the port register cannot select the mode.

Port register (PR)

3 2 1 0 (Initial value: 0000)

— P2S P1HS P1LS

Selects I/O mode for ports P2.

0 : Input mode for P23~P20
1 : Output mode for P23~P20

Selects I/O mode for port P1. (upper 2 bits)

0 : Input mode for P13 and P12
1 : Output mode for P13 and P12

Selects I/O mode for port P1 (lower 2 bits).

0 : Input mode for P11 and P10
1 : Output mode for P11 and P10

Figure 3.1 Programmable I/O port control using port register

TC9028P/F

3.1.2 I/O ports

TC9028P and TC9028F has 4 I/O ports with 15 pins.

(1) Port P0: 4bit input

(2) Ports P1, P2: 4bit programmable input/output

(3) Port P5: 3bit output (P52 and P53 are for large current output)

(1) Port P0 (P03~P00)

Port P0 is a 4bit input port. All its pins are equipped with hold mode cancellation function.

(2) Ports P1 (P13~P10), P2 (P23~P20)

Ports P1, P2 are 4bit programmable I/O ports with latches.

Input or output can be selected by program. (8 types)

Latches are initialized to 1 at reset.

Pins which can be switched using an option to input mode during hold mode are equipped with hold mode cancellation functions.

Po	rt P0 (port	address IPC	10)
3	2	1	0
P03	P02	P01	P00
CV NU3	HCV NIU3	HCAN01	HC V NIOO

Port P1 (port address OP01/IP01)

3	2	1	0
P13	P12	P11	P10
(HCAN13)	(HCAN12)	(HCAN11)	(HCAN10)

Port P2 (port address OP02/IP02)

3	2	1	0
P23	P22	P21	P20
(HCAN23)	(HCAN22)	(HCAN21)	(HCAN20)

Figure 3.2 Ports P0, P1 and P2

(3) P5 (P53~P51) port

Port P5 is a 3bit output port with a latch.

P51 is for P-ch open-drain output. An option allows it to be used for push/pull output.

The latch is initialized to 0 at reset.

P52 is for large current output for driving the send display LED.

The output latch is initialized to 1 at reset.

P53 is for large current output for driving the infrared LED. Resetting the output latch to 1 outputs fOSC/12 (duty 1/3) or fOSC/8 (duty 1/2) sub-carrier frequency for modulation. An option allows selection of fOSC/24 (duty 1/3) or fOSC/16 (duty 1/2) sub-carrier frequency. Sub-carrier frequency (duty) is selected by the command register. The latch is initialized to 0 at reset.

The LSB (P50) of the port P5 is used for selecting the sub-carrier frequency (duty) output from P53 using the write-only command register.

The latch is initialized to 0 at reset.

Although port P5 is an output port, when an input instruction is executed, P5 can read timer/counter output (IT3~IT0).

Port P5, Command Register (port address OP05) and,

Timer/Counter Output (port address IP05)

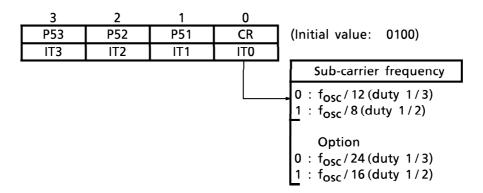


Figure 3.3 Port P5

3.2 Timer/counter

The timer/counter is a 17 step binary counter used to divide the fundamental clock. It outputs a pulse with a cycle selected from steps 10 through 15.

The timer/counter is a 17 step binary counter used to divide the fundamental clock. It outputs a pulse with a cycle selected from steps 10 through 15.

The uses of the timer/counter are listed below. The timer/counter is cleared to 0 at reset, when a timer reset instruction (TMRST) is executed, and when hold mode is cancelled.

- ① Timer generating $f_C/2^{10} \sim f_C/2^{15}$ [Hz] pulses
- 2 Watchdog timer
- 3 Warming-up timer when hold mode is cancelled

3.2.1 Timer register (TR)

The timer register is a 4bit write-only register. It selects the mode when the timer status is read. The timer register is initialized to 0 at reset.

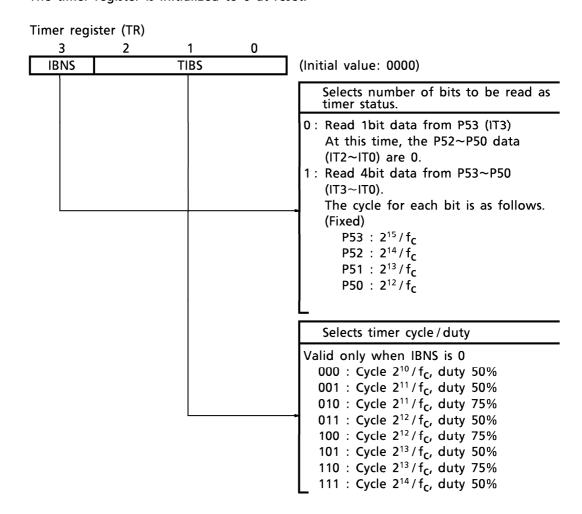


Figure 3.4 Timer/counter output mode control using timer register

3.2.2 Timer counter output (IT3~IT0)

The timer counter is cleared to 0 at reset. It is incremented, from 0, each time the fundamental clock is input. The timer counter output transfers the inverted value of the timer counter to the accumulator or data memory using port P5 input instructions [IN %IP05, A] and [IN %IP05, @LR]. Thus, 1 is read at reset. (Decrement)

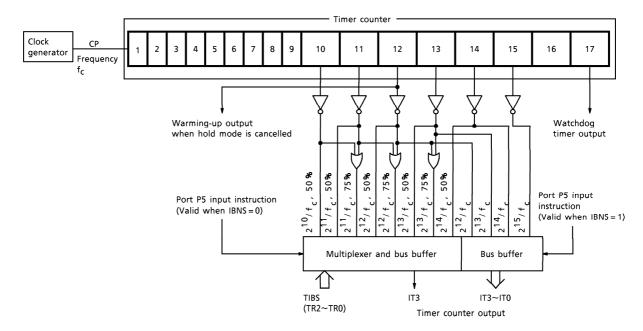


Figure 3.5 Timer counter configuration

3.2.3 Watchdog timer output

The watchdog timer output becomes active $2^{16}/f_C(s)$ after the timer is reset. If the timer is not reset again before timer reset, TC9028P and TC9028F regards this as a CPU runaway and resets the CPU.

4. Low power consumption operation

TC9028P and TC9028F features a hold mode for low power consumption operation.

4.1 Hold mode

The hold function stops system operation and holds the internal states in effect immediately before stopping.

The hold function is controlled by the port hold mode cancellation function and by the hold instruction [HOLD]. The hold cancel function is valid with pins P00~P03, and with pins P10~P13, P20~P23 (HCAN pins) which are switched using and option to input mode during hold mode.

4.1.1 Hold mode

Hold mode is activated by executing the hold instruction [HOLD]. Hold mode continues as long as the HCAN pins are at low level.

The following states are held during hold mode.

- ① Oscillation stops and all internal operations stop.
- 2 The timer counter is cleared to 0.
- 3 Data memory, registers, and port latches hold the states immediately before entering hold mode. (Note that the status flag is set to 1.)
- The program counter holds the 2 addresses after the hold instruction. (After hold mode is cancelled, execution resumes with the instruction following the hold instruction.)

4.1.2 Hold mode cancellation

Hold mode is cancelled and normal operation resumes when high level is input to the HCAN pins during hold mode.

Hold mode is cancelled in the following sequence.

- ① Oscillation begins.
- ② Warming-up for the time required to stabilize oscillation. Internal operation remains stopped during warming-up.

 The warming-up time is $2^{11}/f_{C(s)}$.
- 3 After the warming-up time has elapsed, normal operation resumes from the instruction following the hold instruction.
- (Note) The fundamental clock is divided by the interval timer. If the oscillation frequency fluctuates after hold mode is cancelled, the warming-up time is not exactly the same as the value given above. Thus, the warming-up time has allowance.

Hold mode is also cancelled by setting the RST pin to low level. In this case, the reset operation is performed immediately. Since normal operation begins at the same time the reset operation is cancelled, the RST pin must be kept at the low level for the warming-up time until oscillation becomes stable.

If input to the HCAN pin is at high level, executing the hold instruction does not enter hold mode but instead moves immediately to the cancellation sequence (warming-up). The warming-up time in this case is an undefined value between $0\sim2^{11}/f_{C(s)}$. Therefore, when the hold instruction is executed, input to the HCAN pin must be set to

low level.

5. Reset

If the RST pin remains at low level for more than a minimum of 3 instruction cycles (15 fundamental clocks) when the power supply voltage is within the operating voltage range and oscillation is stable, the system is reset and the internal states are initialized. When the RST pin is set to high level, the reset operation is cancelled and execution of the program at address 000H begins.

Table 5.1 Initialization of internal states by reset

INTERNAL HARDWARE	INITIAL VALUE	INTERNAL HARDWARE	INITIAL VALUE
Program Counter (PC)	000H		Coo doonintion
Status Flag (SF)	1	Output Latches (I/O ports)	of I/O circuits
Port Register (PR)	0000B		or 170 circuits.

Instruction list

FUNCTION Transfer	MNEMONIC			OBJEC	T CODE	OPERATION		AG	CVCLES
FUNCTION	IVII	VEIVIOIVIC	BIN	ARY	HEXADECIMAL	OPERATION	CF	1 1 2 1 2 1 2 1 1 1 1 1 1 1 1 1 1 1 1 1	CTCLES
	LD	A, @LR	0000	0110	06	Acc←RAM (LR)	-	1	1
	LD	A, x	1001	0xxx	90 + x	Acc←RAM (x)	-	1	2
	LDL	A, @DC	0110	0111	67	Acc←ROM (DC) L	-	1	2
	LDH	A, @DC	0110	0110	66	Acc←ROM (DC) H	-	1	2
	ST	A, @LR	0111	0110	76	RAM (LR) ←Acc	-	1	1
	ST	#k, @LR	0011	kkkk	3k	RAM (LR) ←k	-	1	1
	ST	А, х	1001	1xxx	98 + x	RAM (x) ←Acc	-	1	2
Transfer	LD	A, #k	0001	kkkk	1k	Acc←k	-	1	1
	LD	L, #k	0010	kkkk	2k	LR←k	-	1	1
	моч	L, A	0000	1111	OF	Acc←LR	-	1	1
	моч	A, L	0000	1100	0C	LR←Acc	-	1	1
	моч	D, A	0000	1110	0E	Acc←DC	-	1	1
	моч	A, D	0000	1101	0D	DC←Acc	-	1	1
	моч	A, P	0111	1110	7E	PR←Acc	-	1	1
	моч	A, T	1000	1010	8A	TR←Acc	-	1	1
	IN	%p, A	0110	0ррр	60 + p	Acc←PORT (p)	T-	Z	2
Innest / Octoors	IN	%p, @LR	0110	1ppp	68 + p	RAM (LR) ←PORT (p)	-	Z	2
Input / Output	ОИТ	A, %p	0111	0ррр	70 + p	PORT (p) ←Acc	-	1	2
	ОИТ	@LR, %p	0111	1ppp	78 + p	PORT (p) ←RAM (LR)	_	1	2

FUNCTION	NAM	EMONIC		OBJEC	T CODE	OPERATION	CF SF — C C C — C — C — C — C — Z — Z — Z — 1 — 1 1 1 1 1	CYCLES	
TONCHON	IVIIV	LIVIONIC	BIN	4RΥ	HEXADECIMAL	OFERATION	CF	SF	CICLLS
	ADD	A, @LR	0000	0011	03	Acc←Acc + RAM(LR)	_		1
	ADDC	A, @LR	0000	0100	04	Acc←Acc + RAM(LR) + CF	С		1
	ADD	A, #k	0100	kkkk	4k	Acc←Acc + k	_		1
	ADD	L, #k	0101	kkkk	5k	LR←LR + k	_	c	2
Operation	SUBRC	A, @LR	0000	0101	05	Acc←RAM(LR) – Acc – CF	С		1
(Arithmetic &	INC	@LR	0000	1001	09	RAM (LR) ←RAM (LR) +1	 —	c	1
Logical)	DEC	@LR	0000	1000	08	RAM (LR) ←RAM (LR) – 1	_	_	1
Logical)	INC	D	0000	1011	OB	DC←DC + 1	 —	c	1
	DEC	D	0000	1010	0A	DC←DC – 1	—		1
	AND	A, @LR	0000	0000	00	Acc←Acc∧RAM(LR)	-		1
	OR	A, @LR	0000	0001	01	Acc←Acc∨RAM(LR)	-		1
	XOR	A, @LR	0000	0010	02	Acc←Acc ∨ RAM(LR)	 —	Z	1
	CLR	@LR, b	1000	01bb	84 + b	RAM (LR) b←0	_	1	2
Bit Manipulation	SET	@LR, b	1000	00bb	80 + b	RAM (LR) b←1	_	1	2
	TEST	@LR, b	1000	11bb	8C + b	SF←RAM (LR) b	—	*	2
	CLR	CF	1000	1011	8B	CF←0	0	1	2
Flag Manipulation	SET	CF	1000	1001	89	CF←1	1	1	2
	TESTP	CF	0111	0111	77	SF←CF	-	*	1
	BSS	a	11dd	dddd	C0 + d	if SF = 1 then PC←a else null,	_	1	2
Branch						a = PC9-6·d			
	LD	MBR, #k	1011	kkkk	Bk	MBR←k	 	_	1
Culamanutina	CALLS	a	1010	nnnn	An	STACK←PC, PC←a, a = 2n (n = 1~15)	_	_	2
Subroutine	RET		0110	1110	6E	PC←STACK	-	_	2
CDU Control	HOLD		0000	0111	07	hold	_	1	1
CPU Control	NOP		0111	1111	7 F	no operation	-	_	1
Timer Counter Control	TMRST		1000	1000	88	reset timer counter	_	_	1

(Note 1) C : Carry from the highest digit for addition and non-borrow to the highest digit for subtraction.

Z : Zero detection data are 1 when data transferred to the accumulator or RAM are 0000B.

* : Value specified by operation is set.

__ : No flag change.

(Note 2) The PC contains the address following the instruction being executed.

Instruction code map

Instruction cod	ie iliaj	9															
Lower Upper	0	1	2	3	4	5	6	7	8	9	A	В	С	D	E	F	
0	AND A, @LR	OR A, @LR	XOR A, @LR	ADD A, @LR	ADDC A, @LR	SUBRC A, @LR	LD A, @LR	HOLD	DEC @LR	INC @LR	DEC D	INC D	MOV A, L	MOV A, D	MOV D, A	MOV L, A	
1							LD	O A, #k									
2							LD	L, #k									
3							ST	#k, @)LR								
4							ADD	A, #k									
5							ADD	L, #k									
6			IN %	óp, Α			LDH A, @DC	LDL A, IN %p, @LR RET @DC									
7			OUT .	A, %p			ST A, @LR	I CE I I I I I I I I I I I I I I I I I I						NOP			
8		SET @	QLR, b			CLR @	HL, b		TMRST SET MOV CLR TEST @LR, b					②LR, b			
9				LD /	4 , х			ST A, x									
Α							CALLS	a									
В							LD M	BR, #k									
С																	
D							BSS a										
E							boo a										
F																	

(Note 1) Blank code is undefined.

(Note 2) 1-Cycle instruction 2-Cycle instruction

MAXIMUM RATINGS (Ta = 25°C)

CHARACTE	RISTIC	SYMBOL	RATING	UNIT
Power Supply Vol	tage	V _{DD}	- 0.3~5.0	V
Input Voltage		VIN	$V_{SS} - 0.3 \sim V_{DD} + 0.3$	V
Output Current		I _{OUT} (P53)	– 20	mA
Power	TC9028P	D-	350	mW
Dissipation	TC9028F	PD	300	11100
Operating Temper	rature	T _{opr}	- 20~75	٥
Storage Temperat	ure	T _{stg}	-40~125	°C

ELECTRICAL CHARACTERISTICS

RECOMMENDED OPERATING CONDITIONS

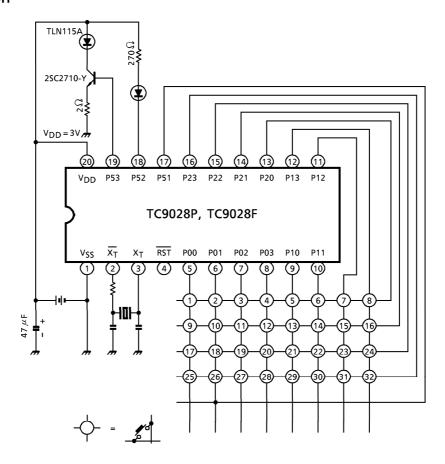
(In *marked items, $Ta = -20 \sim 75$ °C, unless otherwise specified, $V_{CC} = 3.0$ V, Ta = 25°C)

CHARACTERIS	SYMBOL	TEST CIR- CUIT	TEST CONDITION	MIN.	TYP.	MAX.	UNIT	
Operation Power Supp	V _{DD}	_	_	2.0	_	4.0	V	
Oscillation Frequency	fosc	_	_	400	_	800	kHz	
	"H" Level	VIH	_	Except Hysteresis Input	V _{DD} ×0.7	_	V _{DD}	V
Input Voltage	li Levei	V _{IH}	_	Hysteresis Input (RST)	V _{DD} ×0.8		V _{DD}	V
input voitage	"L" Level	VIL	_	Except Hysteresis Input	0		V _{DD} × 0.3	V
	L Level	V _{IL}	_	Hysteresis Input (RST)	0	1	V _{DD} × 0.2	٧

DC CHARACTERISTICS ($V_{DD} = 3.0V$, $T_a = 25$ °C, unless otherwise specified)

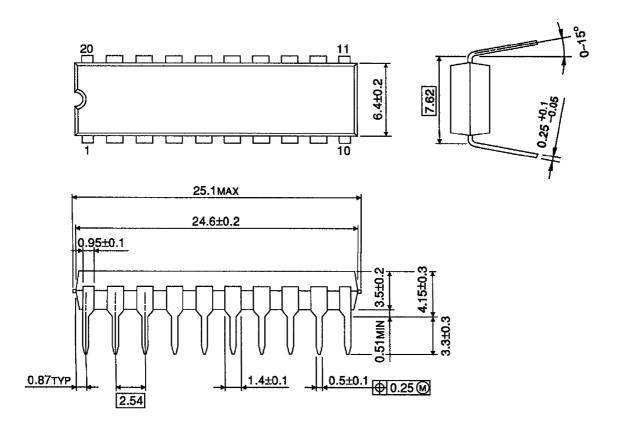
CHARACTERI	SYMBOL	TEST CIR- CUIT	TEST CONDITION	MIN.	TYP.	MAX.	UNIT	
Operation Power Supp	oly Current	lDD	_	f _C = 455kHz	_	_	1.0	mA
Static Dissipation Curr	ent	lQD	_	at Hold Function	_	_	1.0	μΑ
Pulldown Resistance		RD	_	(P0, P1, P2)	100	_	400	kΩ
Pullup Resistance		RU	_	(RST)	25	_	100	kΩ
Output Current	"H" Level	ІОН	_	V _{OH} (P53) = 1.5V	- 10	_	_	m A
"L" Level		lOL	_	V _{OL} (P52) = 1.5V	5	_	_	mA
Input Leak Current		ILI	_	$V_{IN} = V_{DD}, V_{SS}$	- 1.0	_	1.0	μ A

APPLICATION CIRCUIT



OUTLINE DRAWING

DIP20-P-300-2.54A Unit: mm

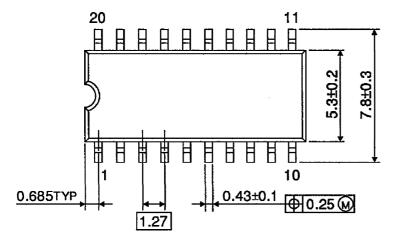


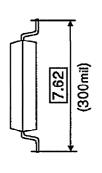
Weight: 1.4g (Typ.)

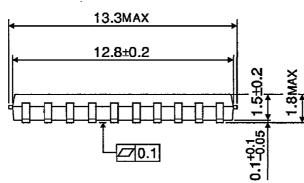
OUTLINE DRAWING

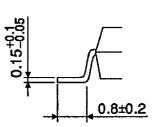
SOP20-P-300-1.27

Unit: mm









Weight: 0.48g (Typ.)